Onsemi

ECOSPARK[®] II, Ignition IGBT

300 mJ, 500 V, N-Channel Ignition IGBT

FGD3050G2

Features

- SCIS Energy = 300 mJ at $T_J = 25^{\circ}C$
- Logic Level Gate Drive
- AEC-Q101 Qualified and PPAP Capable
- This Device is Pb-Free, Halid Free and is RoHS Compliant

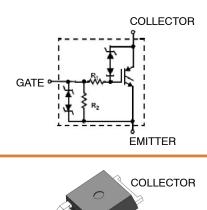
Applications

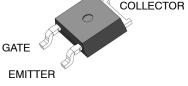
- Automotive Ignition Coil Driver Circuits
- Coil on Plug Application

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

| Symbol | Parameter | Value | Unit |
|----------------------|--|-------------|------|
| BV _{CER} | Collector to Emitter Breakdown Voltage (I _C = 1 mA) | 500 | V |
| BV _{ECS} | Emitter to Collector Voltage – Reverse Battery Condition ($I_C = 10 \text{ mA}$) | 20 | V |
| E _{SCIS25} | I_{SCIS} = 14.2 A, L = 3.0 mHy, R_{GE} = 1 k Ω T_{C} = 25°C | 300 | mJ |
| E _{SCIS150} | I_{SCIS} = 11.0 A, L = 3.0 mHy, R _{GE} = 1 kΩ T _C = 150°C | 180 | mJ |
| I _{C25} | Collector Current Continuous at V_{GE} = 5.0 V, T _C = 25°C | 32 | A |
| I _{C110} | Collector Current Continuous at V _{GE} = 5.0 V, T _C = 110°C | 27 | A |
| V_{GEM} | Gate to Emitter Voltage Continuous | ±10 | V |
| PD | Power Dissipation Total, $T_C = 25^{\circ}C$ | 150 | W |
| | Power Dissipation Derating, $T_C > 25^{\circ}C$ | 1.1 | W/°C |
| TJ | Operating Junction Temperature Range | -40 to +175 | °C |
| T _{STG} | Storage Junction Temperature Range | -40 to +175 | °C |
| ΤL | T _L Max. Lead Temperature for Soldering (Leads at 1.6 mm from case for 10 s) | | °C |
| Т _{РКG} | T _{PKG} Max. Lead Temperature for Soldering (Package Body for 10 s) | | °C |
| ESD | Electrostatic Discharge Voltage at 100 pF, 1500 Ω | 4 | kV |

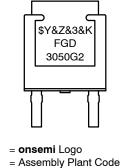
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.





DPAK3 (TO-252 3 LD) CASE 369AS

MARKING DIAGRAM



&Z &3 = 3-Digit Date Code

= 2-Digits Lot Run Traceability Code

&K FGD3050G2 = Specific Device Code

\$Y

ORDERING INFORMATION

See detailed ordering and shipping information on page 6 of this data sheet.

THERMAL CHARACTERISTICS

| Symbol | Characteristic | Max | Units |
|-----------------|-------------------------------------|-----|-------|
| $R_{\theta JC}$ | Thermal Resistance Junction to Case | 0.9 | °C/W |

ELECTRICAL CHARACTERISTICS ($T_C = 25^{\circ}C$ unless otherwise specified)

Current Fall Time-Inductive

t_{fL}

| | | | • • | | | | |
|-----------------------|--|--|------------------------|------|----------|------|-------|
| Symbol | Parameter | Test Conditions | | Min | Тур. | Max. | Units |
| OFF CHARA | ACTERISTICS | - | | | | | |
| BV _{CER} | Collector to Emitter Breakdown Voltage | I_{CE} = 2 mA, V_{GE} = 0 V, R _{GE} = 1 kΩ, T _J = -40 to 150°C | | 470 | - | 530 | V |
| BV _{CES} | Collector to Emitter Breakdown Voltage | I _{CE} = 10 mA, V _{GE} = 0 V, R _{GE} = 0 Ω, T _J = −40 to 150°C | | 495 | - | 555 | V |
| BV _{ECS} | Emitter to Collector Breakdown Voltage | I _{CE} = -75 mA, V _{GE} = 0 V, T _J = 25°C | | 20 | - | - | V |
| BV _{GES} | Gate to Emitter Breakdown Voltage | I _{GES} = ±5 mA | | ±12 | ±14 | - | V |
| I _{CER} | Collector to Emitter Leakage Current | V _{CE} = 250 V R _{GE} = 1 kΩ | $T_J = 25^{\circ}C$ | - | - | 25 | μA |
| | | | T _J = 150°C | - | - | 1 | mA |
| I _{ECS} | Emitter to Collector Leakage Current | V _{EC} = 15 V | $T_J = 25^{\circ}C$ | - | - | 1 | mA |
| | | | T _J = 150°C | - | - | 40 | |
| R ₁ | Series Gate Resistance | | | - | 111 | - | Ω |
| R ₂ | Gate to Emitter Resistance | | | 10 | - | 30 | kΩ |
| ON CHARAG | CTERISTICS | | | | | | |
| V _{CE(SAT)} | Collector to Emitter Saturation Voltage | I_{CE} = 6 A, V_{GE} = 4 V, T_{J} = 25°C | | - | 1.1 | 1.2 | V |
| $V_{CE(SAT)}$ | Collector to Emitter Saturation Voltage | I_{CE} = 10 A, V_{GE} = 4.5 V, T_{J} = 150°C | | - | 1.3 | 1.45 | V |
| $V_{CE(SAT)}$ | Collector to Emitter Saturation Voltage | I_{CE} = 15 A, V_{GE} = 4.5 V, T_{J} = 150°C | | - | 1.6 | 1.75 | V |
| OYNAMIC C | HARACTERISTICS | | | | | | |
| Q _{G(ON)} | Gate Charge | I_{CE} = 10 A, V_{CE} = 12 V, V_{GE} = 5 V | | - | 22 | - | nC |
| V _{GE(TH)} | Gate to Emitter Threshold Voltage | I _{CE} = 1 mA V _{CE} = V _{GE} | $T_J = 25^{\circ}C$ | 1.3 | 1.6 | 2.2 | V |
| . / | | | T _J = 150°C | 0.75 | 1.1 | 1.8 | |
| V _{GEP} | Gate to Emitter Plateau Voltage | V _{CE} = 12 V, I _{CE} = 10 A | | - | 2.7 | - | V |
| SWITCHING | CHARACTERISTICS | | | | | | |
| t _{d(ON)R} | Current Turn–On Delay Time–Resistive | $\begin{array}{l} V_{CE} = 14 \text{ V}, \text{ R}_{L} = 1 \ \Omega, \\ V_{GE} = 5 \text{ V}, \text{ R}_{G} = 1 \ \text{k}\Omega, \end{array}$ | | - | 0.9 | 4 | μs |
| t _{rR} | Current Rise Time-Resistive | 1 | | - | 1.6 | 7 | μs |
| t _{d(OFF)} L | Current Turn-Off Delay Time-Inductive | V_{CE} = 300 V, L = 2 mH, V_{GE} = 5 V, R_G = 1 k Ω , | | - | 5.4 | 15 | μs |
| | 1 | 1 | | | <u> </u> | | 1 |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

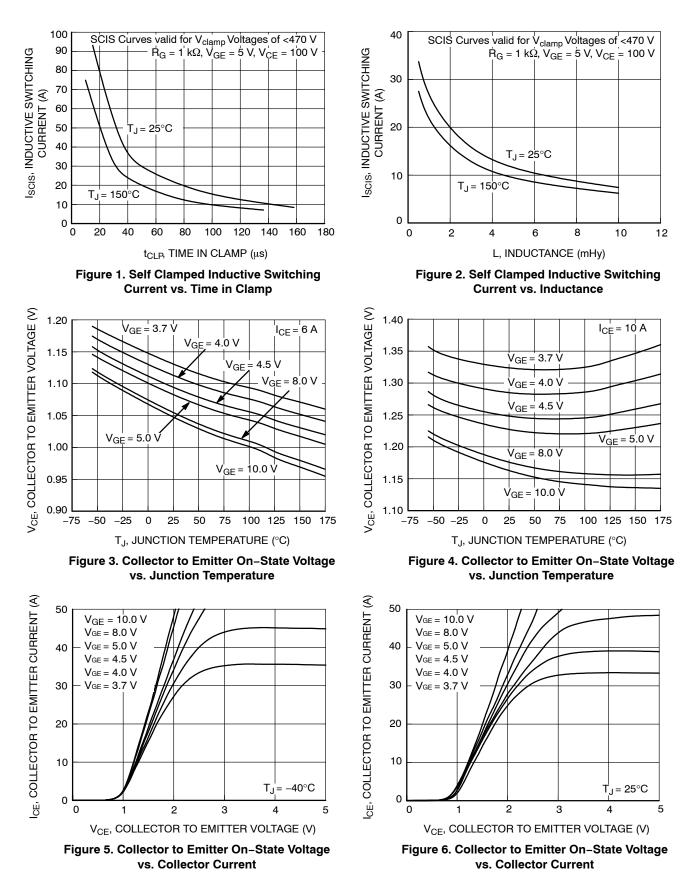
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1.4

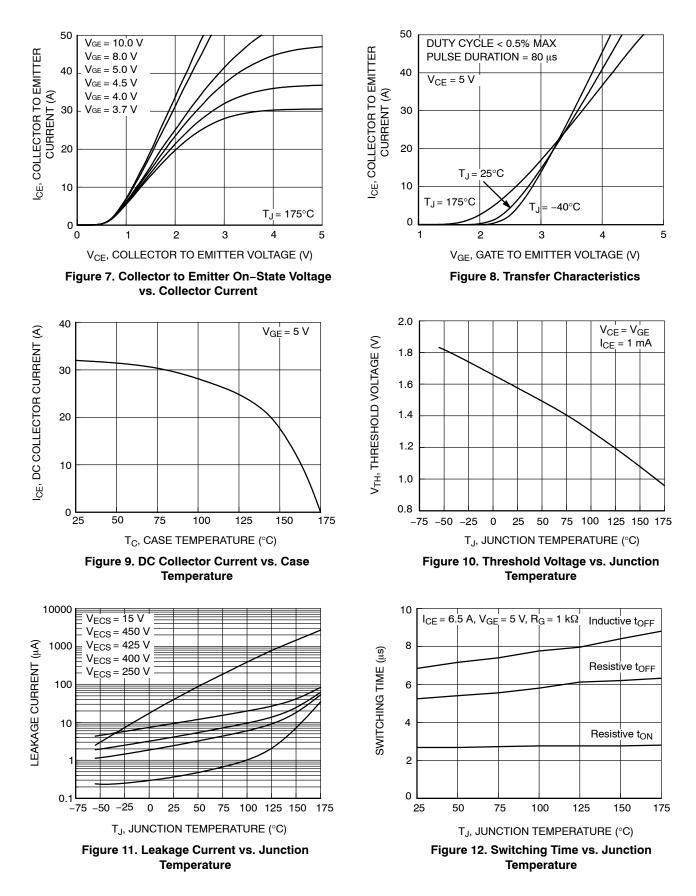
15

μs

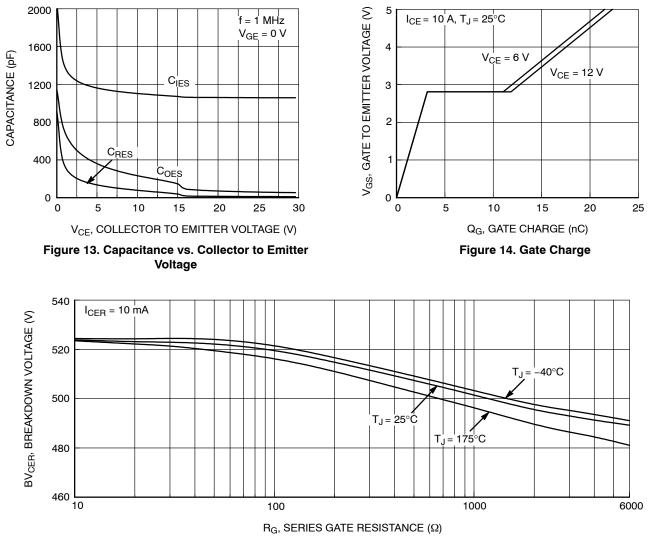
TYPICAL CHARACTERISTICS



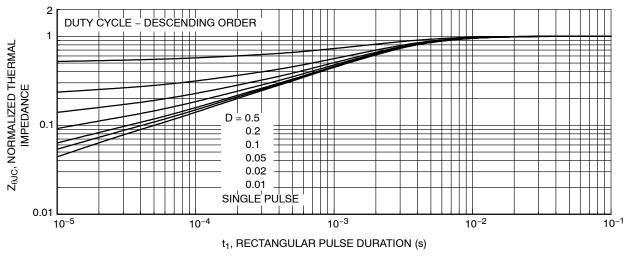
TYPICAL CHARACTERISTICS (continued)



TYPICAL CHARACTERISTICS (continued)



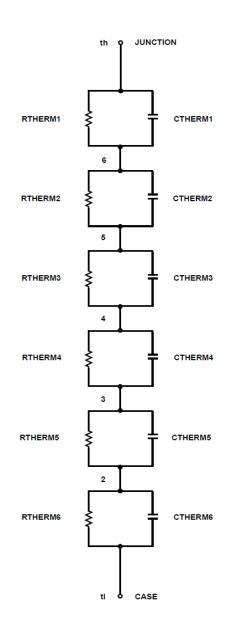






SPICE THERMAL MODEL

| CTHERM1 | tł | n 6 5.7337E-05 |
|--------------------|--------|--------------------------------|
| CTHERM2 | 6 | 5 5.3736E-03 |
| CTHERM3 | 5 | 4 1.1141E-03 |
| CTHERM4 | 4 | 3 2.8690E-04 |
| CTHERM5 | 3 | 2 7.4429E-04 |
| CTHERM6 | 2 | tl 3.7019E-03 |
| | | |
| | | |
| RTHERM1 | tł | n 6 6.6403E-03 |
| RTHERM1 RTHERM2 | 01 | n 6 6.6403E-03 5 5.8449E-01 |
| | 01 | |
| RTHERM2 | 6 | 5 5.8449E-01 |
| RTHERM2 RTHERM3 | 6 5 | 5 5.8449E-01 4 5.3930E-02 |



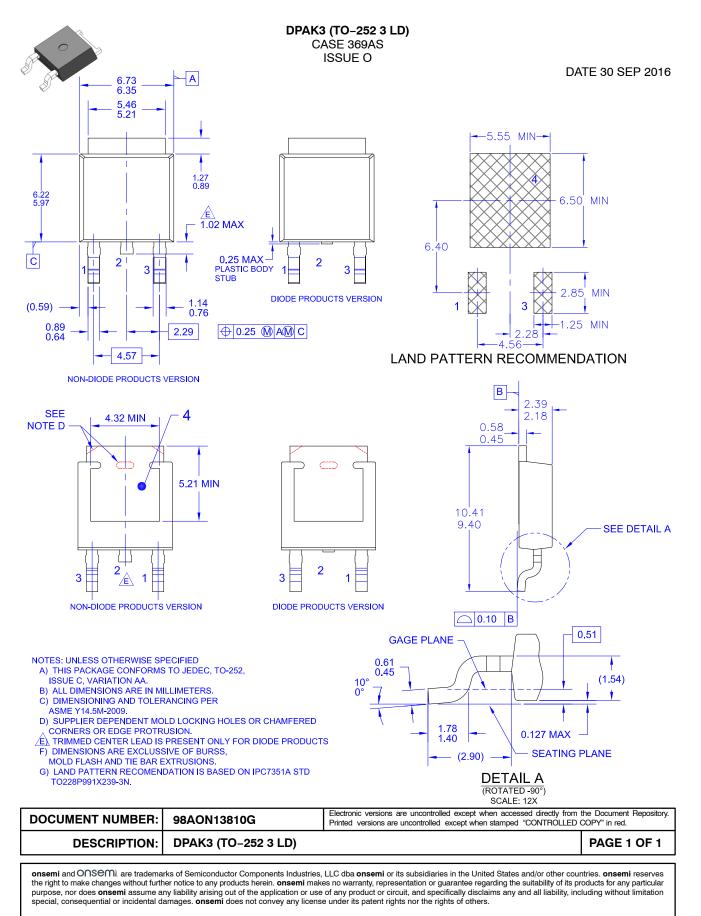
PACKAGE MARKING AND ORDERING INFORMATION

| Device | Device Marking | Package | Shipping [†] |
|-----------|----------------|----------------------------------|-----------------------|
| FGD3050G2 | FGD3050G2 | DPAK3 (TO-252 3 LD) (Pb-Free) | 2500 / Tape & Reel |

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D</u>.

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MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS



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